

LIEC 2027

2027 International Conference on Language Intelligence and Educational Computing

June 11–13, 2027 · Wuhan, China · EI Compendex & Scopus

LIEC 2027 provides an international interdisciplinary forum for researchers, educators, computer scientists and industry professionals to present original research and exchange ideas at the intersection of **language intelligence, artificial intelligence, computing and digital education**. The conference welcomes the submission of original, unpublished research papers.

Topics of Interest

- Natural Language Processing and Language Intelligence
- Large Language Models and Generative AI
- AI-Enhanced Digital Education
- Intelligent Tutoring and Personalized Learning
- Learning Analytics and Educational Data Mining
- Language Education and AI-Assisted Language Learning

Important Dates

Paper Submission Deadline	April 30, 2027
Notification of Acceptance	May 15, 2027
Camera-Ready Submission	May 31, 2027
Conference Dates	June 11–13, 2027

Submission & Contact

Papers should be formatted according to the LIEC 2027 template and submitted through the conference submission system. All submissions undergo peer review. For inquiries, please contact the secretariat:

Email: liecconf@163.com

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Official Website: 47.86.57.69/lide2027